

**AMENDMENT TRANSMITTAL LETTER (Large Entity)**

Applicant(s): Hsu, et al.

Docket No.

FIS920040114US1

Application No.

10/710,880

Filing Date

August 10, 2004

Examiner

Anyu, Igwe U.

Customer No.

29154

Group Art Unit

2891

Confirmation No.

4879

Invention: **PARTIAL WAFER BONDING AND DICING****COMMISSIONER FOR PATENTS:**

Transmitted herewith is an amendment in the above-identified application.  
The fee has been calculated and is transmitted as shown below.

**RECEIVED  
CENTRAL FAX CENTER****JAN 11 2006****CLAIMS AS AMENDED**

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	26 -	20 =	6	x \$50.00	\$300.00
INDEP. CLAIMS	3 -	3 =	0	x \$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$300.00

- ☐ No additional fee is required for amendment.
- ☒ Please charge Deposit Account No. 09-0458 in the amount of \$300.00
- ☐ A check in the amount of to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 09-0458
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Signature

Dated: January 11, 2006

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Pamela M. Riley

cc:

**RECEIVED**  
**CENTRAL FAX CENTER****JAN 11 2006****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re patent application of:  
Hsu, et al.

Serial No.: 10/710,880

Filed: August 10, 2004

Group Art Unit: 2891

Examiner: Anya, Igwe U.

Atty. Docket No.: FIS920040114US1

For: PARTIAL WAFER BONDING AND DICING

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Pamela M. Riley

**AMENDMENT UNDER 37 C.F.R. §1.116**

Mail Stop Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action mailed November 29, 2005,  
setting a three-month statutory period for response. Therefore, this amendment is timely  
filed. Please amend the above-identified patent application as follows:

01/12/2006 TL0111 00000033 090458 10710880

01 FC:1202 300.00 DA

10/710,880

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